

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
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APPLICATION STANDARD									
RATING	OPERATING TEMPERATURE RANGE	-55 °C TO 85 °C			STORAGE TEMPERATURE RANGE	-10 °C TO 60 °C			
	VOLTAGE	AC 50 V			OPERATING HUMIDITY RANGE	RELATIVE HUMIDITY : 95 % MAX (NO DEW CONDENSATION IS PERMITTED)			
	CURRENT	0.3 A							
SPECIFICATIONS									
ITEM		TEST METHOD			REQUIREMENT			QT	AT
CONSTRUCTION									
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING			X	X
MARKING		CONFIRMED VISUALLY.						X	X
ELECTRICAL CHARACTERISTICS									
CONTACT RESISTANCE		100 mA (DC OR 1000 Hz).			70 mΩ MAX.			X	X
INSULATION RESISTANCE		100 V DC.			100 MΩ MIN.			X	—
VOLTAGE PROOF		150 V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.			X	X
MECHANICAL CHARACTERISTICS									
INSERTION AND WITHDRAWAL FORCES		MEASURED BY APPLICABLE CONNECTOR.			INSERTION FORCE: 48 N MAX. WITHDRAWAL FORCE: 2 N MIN.			X	—
MECHANICAL OPERATION		50 TIMES INSERTION AND EXTRACTIONS.			1) CONTACT RESISTANCE: 80 mΩ MAX. 2) NO DAMAGE, CRACK AND LOOSENESS OF PART.			X	—
VIBRATION		FREQUENCY: 10 TO 55 Hz, SINGLE AMPLITUDE: 0.75 mm, m/s^2 AT 10 CYCLES FOR 3 DIRECTIONS.			1) NO ELECTRICAL DISCONTINUITY OF 1 μs MIN. 2) NO DAMAGE, CRACK AND LOOSENESS OF PART.			X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.						X	—
ENVIRONMENTAL CHARACTERISTICS									
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C. 90~95 %, 96 h.			1) CONTACT RESISTANCE: 80 mΩ MAX. 2) INSULATION RESISTANCE: 100 MΩ MIN. 3) NO DAMAGE, CRACK AND LOOSENESS OF PART.			X	—
RAPID CHAGE OF TEMPERTURE		TEMPERTURE -55→-15→35→ 85→15→35°C TIME 30→ 2~ 3→ 30→ 2~ 3 min. UNDER 5 CYCLES.						X	—
DRY HEAT		EXPOSED AT 85 °C. 96 h.			1) CONTACT RESISTANCE: 80 mΩ MAX. 2) NO DAMAGE, CRACK AND LOOSENESS OF PART.			X	—
COLD		EXPOSED AT -55 °C. 96 h.						X	—
CORROSION SALT MIST		EXPOSED IN 5 % SALT WATER SPRAY FOR 48 h.			NO HEAVY CORROSION.			X	—
SULPHUR DIOXIDE		EXPOSED IN 10 PPM FOR 96 h. (TEST STANDARD: JIS C 0090)			1) CONTACT RESISTANCE: 80 mΩ MAX. 2) NO HEAVY CORROSION.			X	—
RESISTANCE TO SOLDERING HEAT		REFLOW : RECOMMENDED TEMPERATURE PROFILE <p>25°C (60 S) 150°C 160°C 240°C 5 S MAX 200°C (30 S) (20~30 S)</p> <p>TO BE TESTED UNDER THE ABOVE CONDITIONS.</p>			NO MELTING OF RESIN WHICH AFFECTS THE PERFORMANCE OF COMPONENT.			X	—
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 235 °C FOR IMMERSION DURATION, 2 s.			NO PINHOLE OR DEWETTING ON SOLDERED SURFACE.			X	—
REMARKS				DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED	
				<i>Matsukawa</i>	<i>Matsukawa</i>	<i>H. Okawa</i>	<i>J. Yoshimura</i>		
UNLESS OTHERWISE SPECIFIED, REFER TO JIS C 5402.				00.06.20	00.06.20	00.06.21	00.06.23		
NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST X: APPLICABLE TEST									
HS HIROSE ELECTRIC CO., LTD.				SPECIFICATION SHEET			PART NO. FX11B- 80P - SV		
CODE NO.(OLD)		DRAWING NO.		CODE NO.		1		1	
CL		ELC4 - 152613		CL 573 - 0558- 4					

FORM NO. 231-1

TO
PCK